

LNPTM STAT-KONTM COMPOUND DE006ER

DC-1006 EM MR

DESCRIPTION

LNP STAT-KON DE006ER compound is based on Polycarbonate (PC) resin containing 30% carbon fiber. Added features of this grade include: Easy Molding, Mold Release, Electrically Conductive.

GENERAL INFORMATION

Features	Electrically Conductive, Good Processability, Enhanced mold release, Carbon fiber filled, High stiffness/Strength
Fillers	Carbon Fiber
Polymer Types	Polycarbonate (PC)
Processing Techniques	Injection Molding

INDUSTRY

Electrical and Electronics
Industrial

SUB INDUSTRY

Electronic Components
Material Handling

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, break	150	MPa	ASTM D638
Tensile Strain, break	1.8	%	ASTM D638
Tensile Modulus, 50 mm/min	19580	MPa	ASTM D638
Flexural Stress	220	MPa	ASTM D790
Flexural Modulus	14540	MPa	ASTM D790
Tensile Stress, break	148	MPa	ISO 527
Tensile Strain, break	1.8	%	ISO 527
Tensile Modulus, 1 mm/min	16700	MPa	ISO 527
Flexural Stress	226	MPa	ISO 178
Flexural Modulus	16500	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, unnotched, 23°C	484	J/m	ASTM D4812
Izod Impact, notched, 23°C	70	J/m	ASTM D256
Instrumented Dart Impact Energy @ peak, 23°C	9	J	ASTM D3763
Izod Impact, unnotched 80°10°4 +23°C	32	kJ/m ²	ISO 180/1U
Izod Impact, notched 80°10°4 +23°C	7	kJ/m ²	ISO 180/1A
THERMAL ⁽¹⁾			
HDT, 0.45 MPa, 3.2 mm, unannealed	143	°C	ASTM D648
HDT, 1.82 MPa, 3.2mm, unannealed	141	°C	ASTM D648
CTE, -40°C to 40°C, flow	2.71E-05	1/°C	ASTM E831
CTE, -40°C to 40°C, xflow	2.79E-05	1/°C	ASTM E831

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
CTE, -40°C to 40°C, flow	2.71E-05	1 / °C	ISO 11359-2
CTE, -40°C to 40°C, xflow	2.78E-05	1 / °C	ISO 11359-2
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	140	°C	ISO 75 /Af
PHYSICAL ⁽¹⁾			
Density	1.3	g / cm ³	ASTM D792
Moisture Absorption, (23°C/50% RH/24 hrs)	0.14	%	ASTM D570
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.1 – 0.3	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	0.3 – 0.4	%	ASTM D955
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.1 – 0.3	%	ISO 294
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	0.35 – 0.4	%	ISO 294
Density	1.3	g / cm ³	ISO 1183
Moisture Absorption (23°C / 50% RH)	0.21	%	ISO 62
ELECTRICAL ⁽¹⁾			
Surface Resistivity ⁽³⁾	1.E+02 – 1.E+06	Ω	ASTM D257
INJECTION MOLDING ⁽⁴⁾			
Drying Temperature	120	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	305 – 325	°C	
Front - Zone 3 Temperature	320 – 330	°C	
Middle - Zone 2 Temperature	310 – 320	°C	
Rear - Zone 1 Temperature	295 – 305	°C	
Mold Temperature	80 – 110	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design

(2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.

(3) Measurement meets requirements as specified in ASTM D4496.

(4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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